

# isc N-Channel MOSFET Transistor

# IRFZ44Z, IIRFZ44Z

## • FEATURES

- Static drain-source on-resistance:  
 $R_{DS(on)} \leq 13.9m\Omega$
- Enhancement mode
- Fast Switching Speed
- 100% avalanche tested
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

## • DESCRIPTION

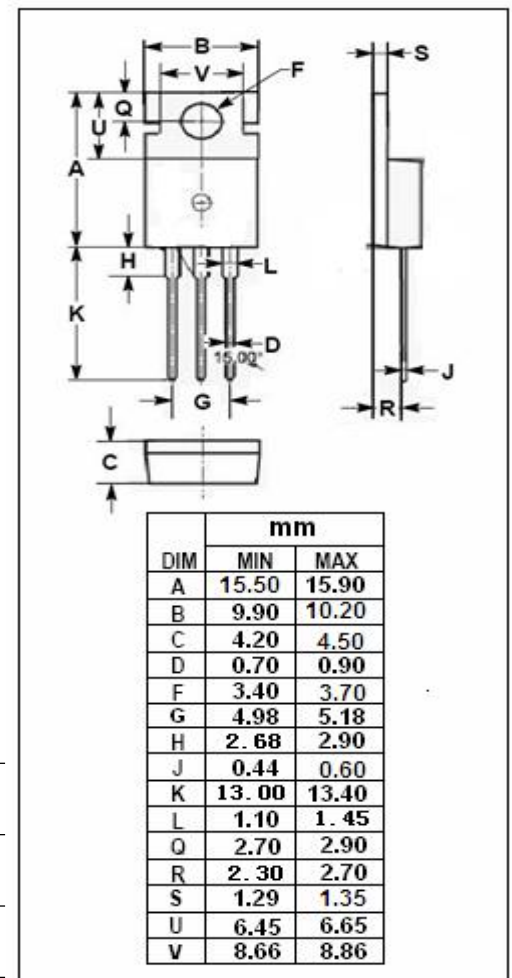
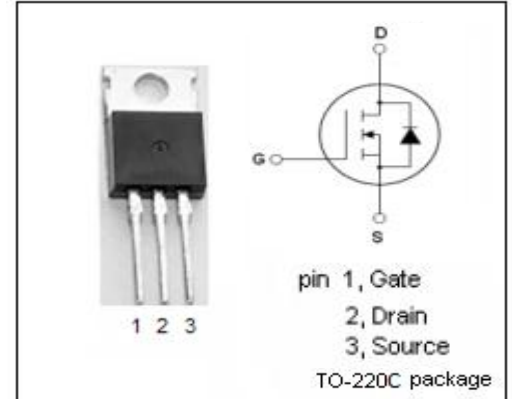
- reliable device for use in a wide variety of applications

## • ABSOLUTE MAXIMUM RATINGS( $T_a=25^\circ C$ )

| SYMBOL    | PARAMETER                            | VALUE    | UNIT       |
|-----------|--------------------------------------|----------|------------|
| $V_{DS}$  | Drain-Source Voltage                 | 55       | V          |
| $V_{GS}$  | Gate-Source Voltage                  | $\pm 20$ | V          |
| $I_D$     | Drain Current-Continuous             | 51       | A          |
| $I_{DM}$  | Drain Current-Single Pulsed          | 200      | A          |
| $P_D$     | Total Dissipation @ $T_c=25^\circ C$ | 80       | W          |
| $T_j$     | Max. Operating Junction Temperature  | 175      | $^\circ C$ |
| $T_{stg}$ | Storage Temperature                  | -55~175  | $^\circ C$ |

## • THERMAL CHARACTERISTICS

| SYMBOL         | PARAMETER                             | MAX  | UNIT         |
|----------------|---------------------------------------|------|--------------|
| $R_{th(ch-c)}$ | Channel-to-case thermal resistance    | 1.87 | $^\circ C/W$ |
| $R_{th(ch-a)}$ | Channel-to-ambient thermal resistance | 62   | $^\circ C/W$ |



**isc N-Channel MOSFET Transistor****IRFZ44Z, IIRFZ44Z****ELECTRICAL CHARACTERISTICS**T<sub>C</sub>=25°C unless otherwise specified

| SYMBOL              | PARAMETER                      | CONDITIONS                                                | MIN | TYP | MAX  | UNIT |
|---------------------|--------------------------------|-----------------------------------------------------------|-----|-----|------|------|
| BV <sub>DSS</sub>   | Drain-Source Breakdown Voltage | V <sub>GS</sub> =0V; I <sub>D</sub> = 250 μA              | 55  |     |      | V    |
| V <sub>GS(th)</sub> | Gate Threshold Voltage         | V <sub>DS</sub> =V <sub>GS</sub> ; I <sub>D</sub> =250 μA | 2.0 |     | 4.0  | V    |
| R <sub>DS(on)</sub> | Drain-Source On-Resistance     | V <sub>GS</sub> =10V; I <sub>D</sub> =31A                 |     |     | 13.9 | mΩ   |
| I <sub>GSS</sub>    | Gate-Source Leakage Current    | V <sub>GS</sub> =±20V                                     |     |     | ±0.2 | μA   |
| I <sub>DSS</sub>    | Drain-Source Leakage Current   | V <sub>DS</sub> =55V; V <sub>GS</sub> = 0V                |     |     | 20   | μA   |
| V <sub>SD</sub>     | Diode forward voltage          | I <sub>S</sub> =31A, V <sub>GS</sub> = 0 V                |     |     | 1.2  | V    |

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